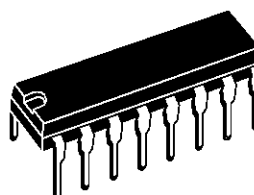


## DUAL POWER AMPLIFIER

- SUPPLY VOLTAGE DOWN TO 3 V
- LOW CROSSOVER DISTORSION
- LOW QUIESCENT CURRENT
- BRIDGE OR STEREO CONFIGURATION



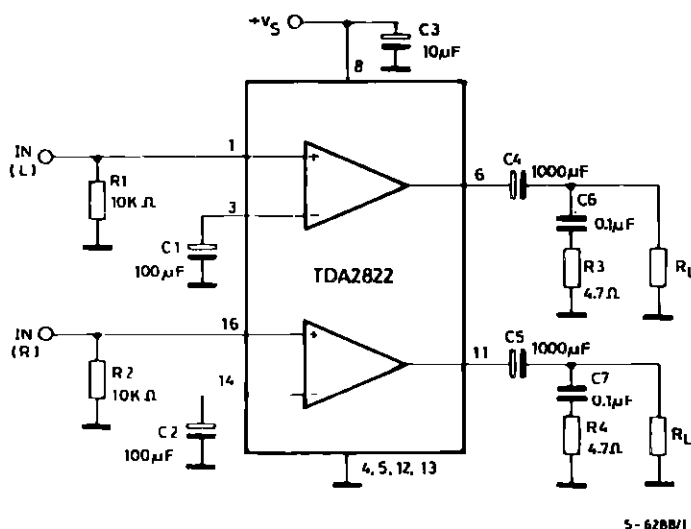
**POWERDIP**  
(Plastic 12+2+2)

**ORDERING NUMBER : TDA2822**

### DESCRIPTION

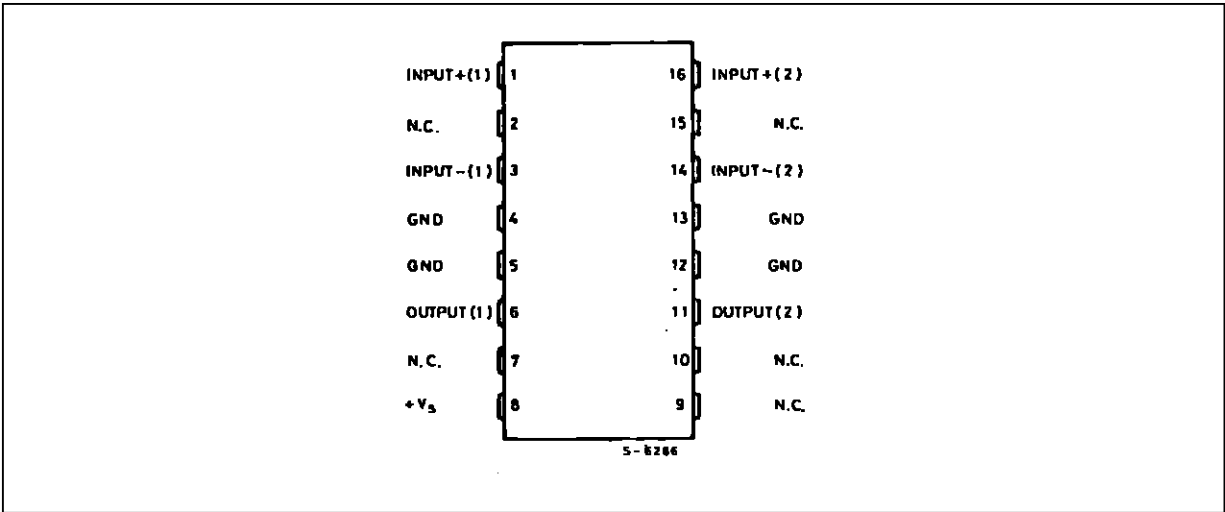
The TDA2822 is a monolithic integrated circuit in 12+2+2 powerdip, intended for use as dual audio power amplifier in portable radios and TS sets.

### TYPICAL APPLICATION CIRCUIT (STEREO)

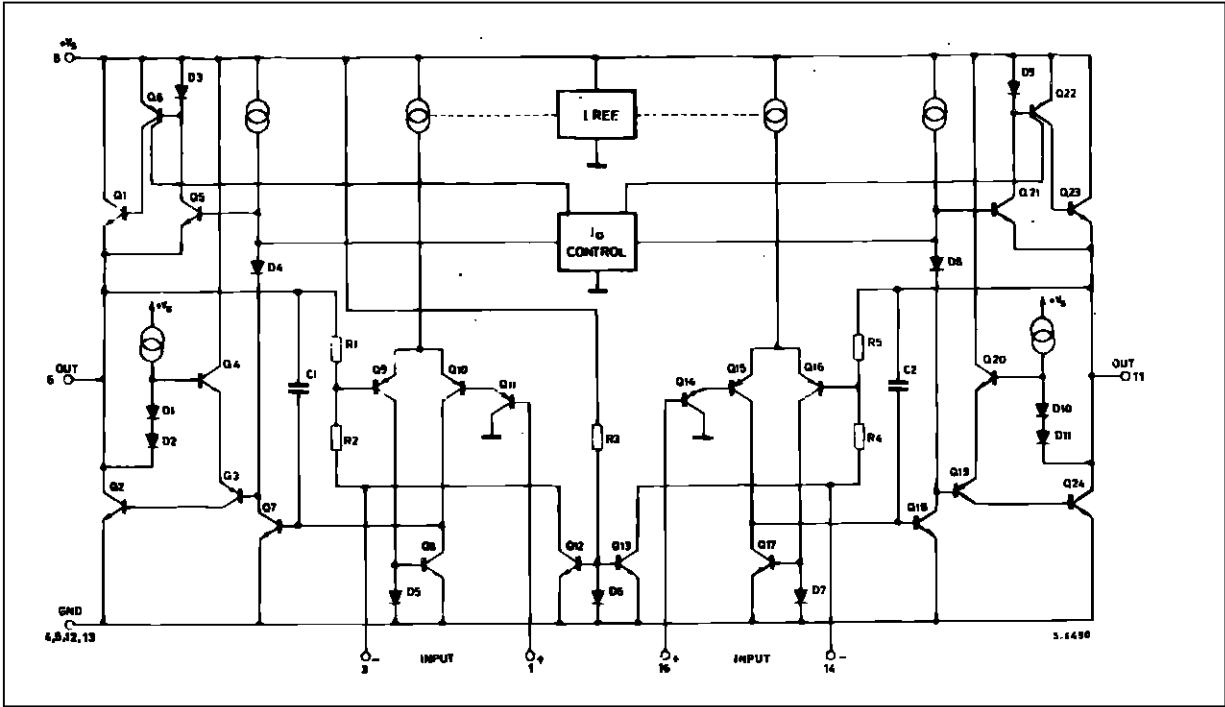


TDA2822

PIN CONNECTION (top view)



SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$V_s$	Supply Voltage	15	V
$I_o$	Output Peak Current	1.5	A
$P_{tot}$	Total Power Dissipation at $T_{amb} = 50\text{ }^{\circ}\text{C}$ at $T_{case} = 70\text{ }^{\circ}\text{C}$	1.25 4	W W
$T_{stg}, T_j$	Storage and Junction Temperature	- 40 to 150	$^{\circ}\text{C}$

## THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{th\ j-amb}$	Thermal Resistance Junction-ambient	Max 80	$^{\circ}C/W$
$R_{th\ j-case}$	Thermal Resistance Junction-pins	Max 20	$^{\circ}C/W$

ELECTRICAL CHARACTERISTICS ( $V_s = 6\ V$ ,  $T_{amb} = 25\ ^{\circ}C$ , unless otherwise specified)

STEREO (test circuit of fig. 1)

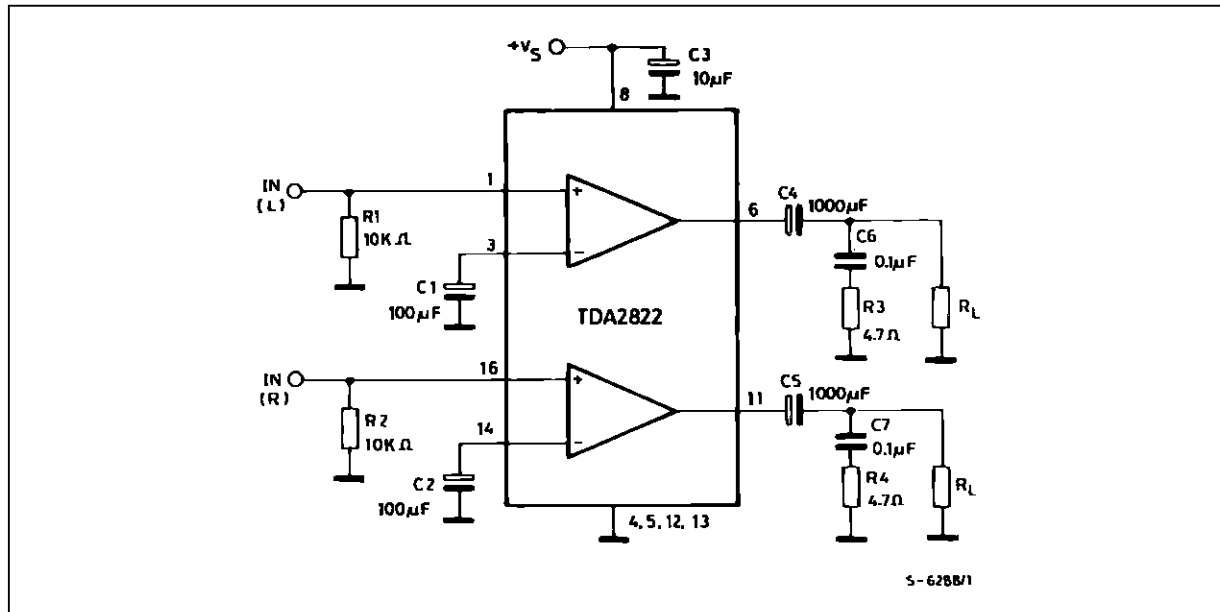
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_s$	Supply Voltage		3		15	V
$V_c$	Quiescent Output Voltage	$V_s = 9\ V$ $V_s = 6\ V$		4 2.7		V V
$I_d$	Quiescent Drain Current			6	12	mA
$I_b$	Input Bias Current			100		nA
$P_o$	Output Power (each channel)	$d = 10\ %$ $f = 1\ kHz$ $V_s = 9\ V$ $R_L = 4\ \Omega$ $V_s = 6\ V$ $R_L = 4\ \Omega$ $V_s = 4.5\ V$ $R_L = 4\ \Omega$	1.3 0.45	1.7 0.65 0.32		W W W
$G_v$	Closed Loop Voltage Gain	$f = 1\ kHz$	36	39	41	dB
$R_i$	Input Resistance	$f = 1\ kHz$	100			k $\Omega$
$e_N$	Total Input Noise	$R_s = 10\ k\Omega$ $B = 22\ Hz\ to\ 22\ kHz$ Curve A		2.5 2		$\mu V$ $\mu V$
SVR	Supply Voltage Rejection	$f = 100\ Hz$	24	30		dB
CS	Channel Separation	$R_g = 10\ k\Omega$ $f = 1\ kHz$		50		dB

BRIDGE (test circuit of fig. 2)

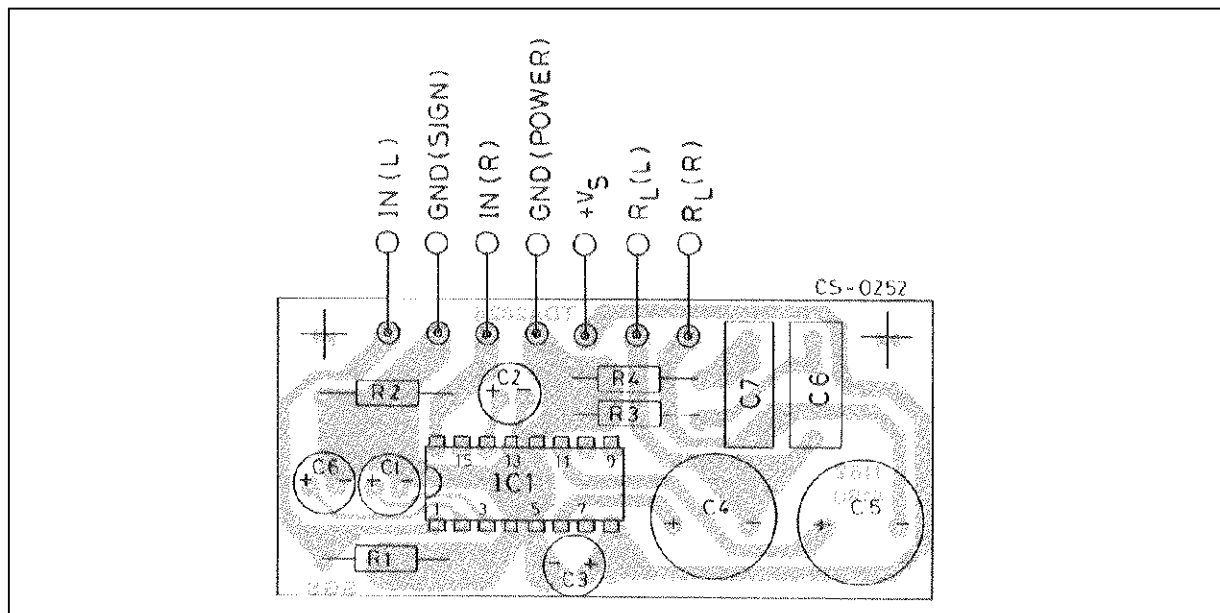
$V_s$	Supply Voltage		3		15	V
$I_d$	Quiescent Drain Current	$R_L = \infty$		6	12	mA
$V_{os}$	Output Offset Voltage	$R_L = 8\ \Omega$		10	60	mV
$I_b$	Input Bias Current			100		nA
$P_o$	Output Power	$d = 10\ %$ $f = 1\ kHz$ $V_s = 9\ V$ $R_L = 8\ \Omega$ $V_s = 6\ V$ $R_L = 8\ \Omega$ $V_s = 4.5\ V$ $R_L = 4\ \Omega$	2.7 0.9	3.2 1.35 1		W W W
$d$	Distortion ( $f = 1\ kHz$ )	$R_L = 8\ \Omega$ $P_o = 0.5\ W$		0.2		%
$G_v$	Closed Loop Voltage Gain	$f = 1\ kHz$		39		dB
$R_i$	Input Resistance	$f = 1\ kHz$	100			k $\Omega$
$e_N$	Total Input Noise	$R_s = 10\ k\Omega$ $B = 22\ Hz\ to\ 22\ kHz$ Curve A		3 2.5		$\mu V$ $\mu V$
SVR	Supply Voltage Rejection	$f = 100\ Hz$		40		dB

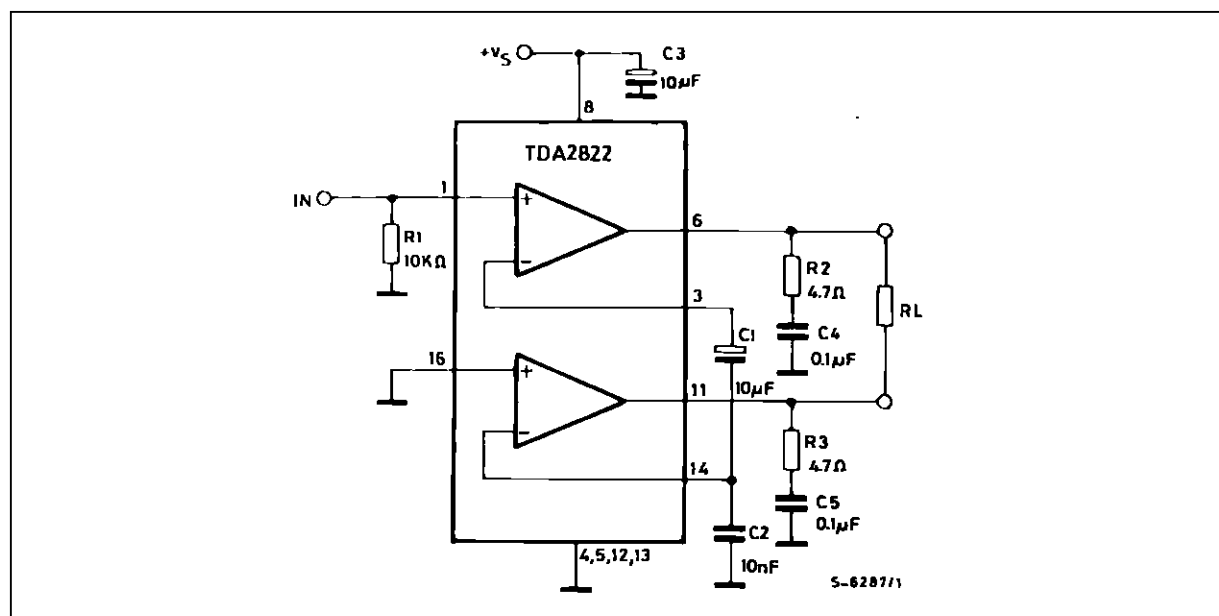
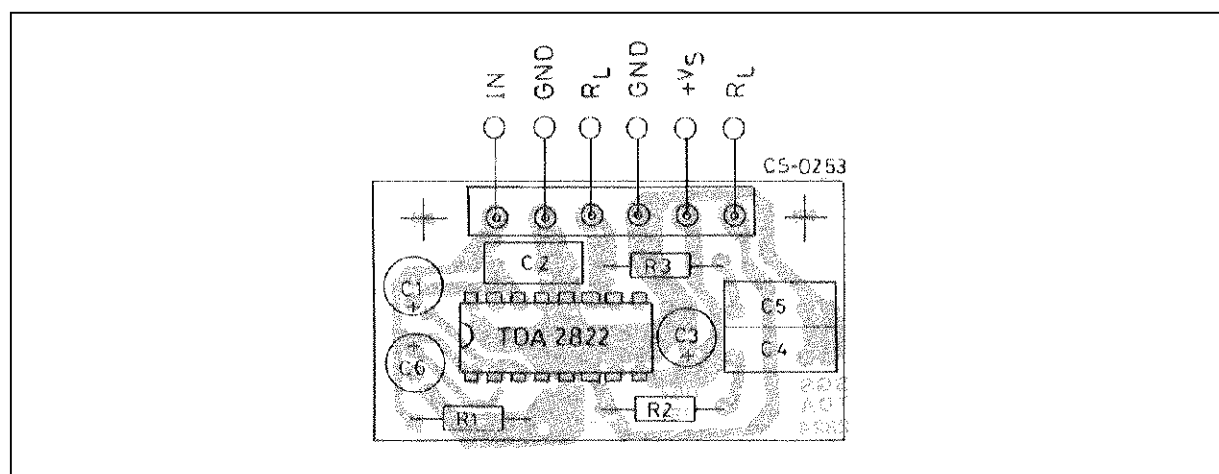
## TDA2822

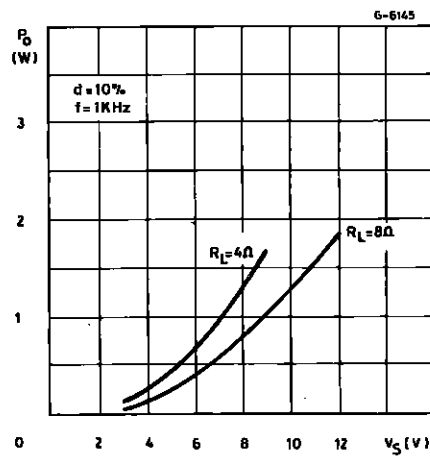
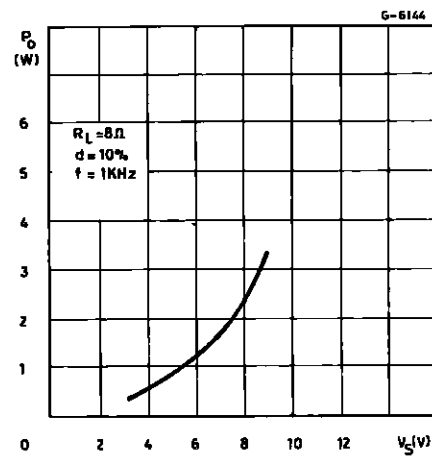
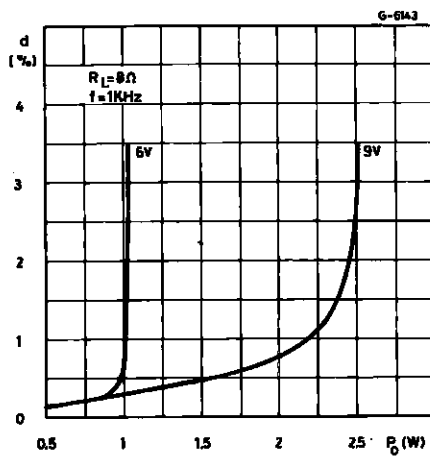
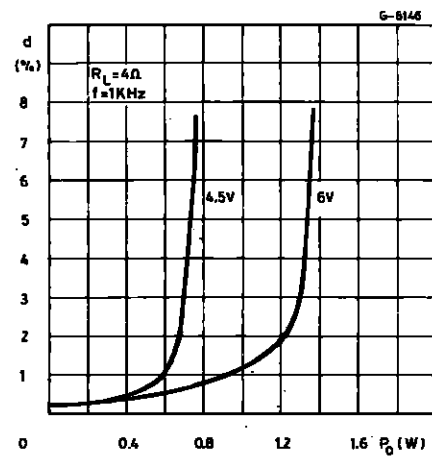
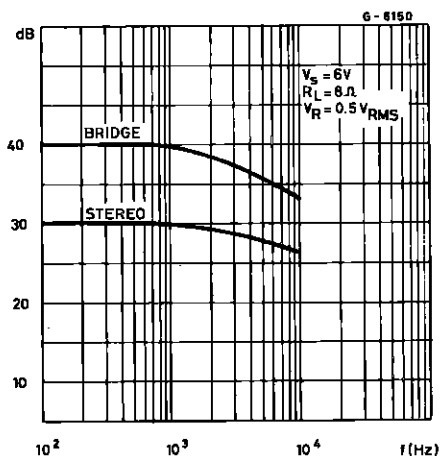
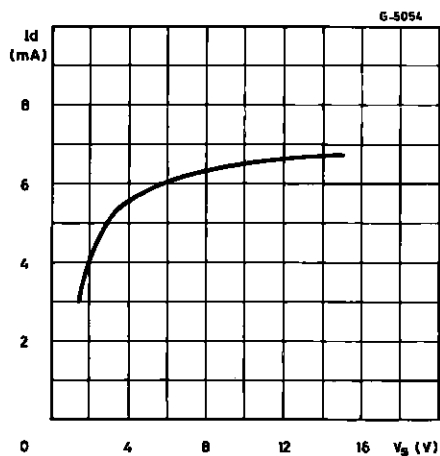
**Figure 1 :** Test Circuit (stereo).



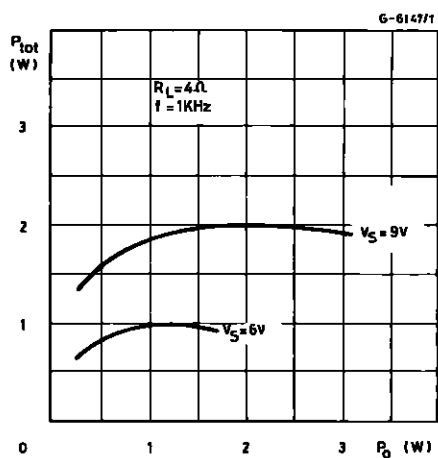
**Figure 2 :** P.C. Board and Components Layout of the Circuit of Figure 1 (1:1 scale).



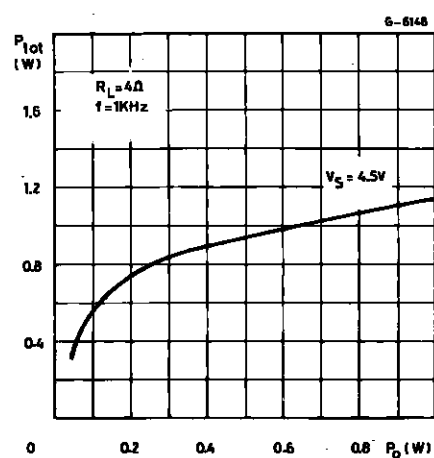
**Figure 3 :** Test Circuit (bridge).**Figure 4 :** P.C. Board and Components Layout of the Circuit of Figure 3 (1:1 scale).

**Figure 5 :** Output Power vs. Supply Voltage (Stereo).**Figure 6 :** Output Power vs. Supply Voltage (Bridge).**Figure 7 :** Distorsion vs. Output Power (Bridge).**Figure 8 :** Distorsion vs. Output Power (Bridge).**Figure 9 :** Supply Voltage Rejection vs. Frequency.**Figure 10 :** Quiescent Current vs. Supply Voltage.

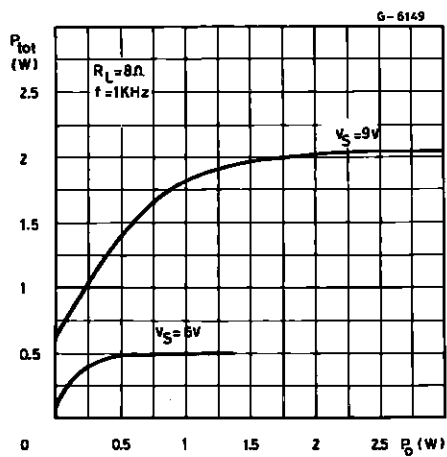
**Figure 11 :** Total Power Dissipation vs. Output Power (Stereo).



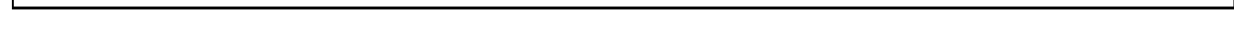
**Figure 12 :** Total Power Dissipation vs. Output Power (Bridge).



**Figure 13 :** Total Power Dissipation vs. Output Power (Bridge).



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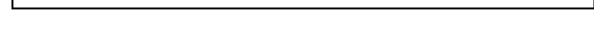
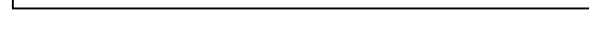


The  $R_{th\ j-amb}$  of the TDA2822 can be reduced by sol-

The diagram of Figure 17 shows the maximum dis-

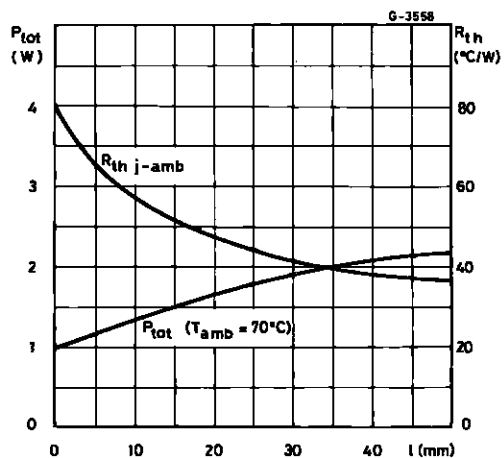
**Figure 15 :** Example of P.C. Board Copper Area

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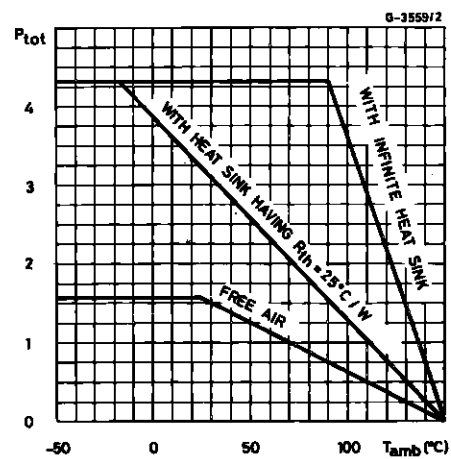




**Figure 6 :** Maximum Dissipable Power and Junction to Ambient Thermal Resistance vs. Side "D".



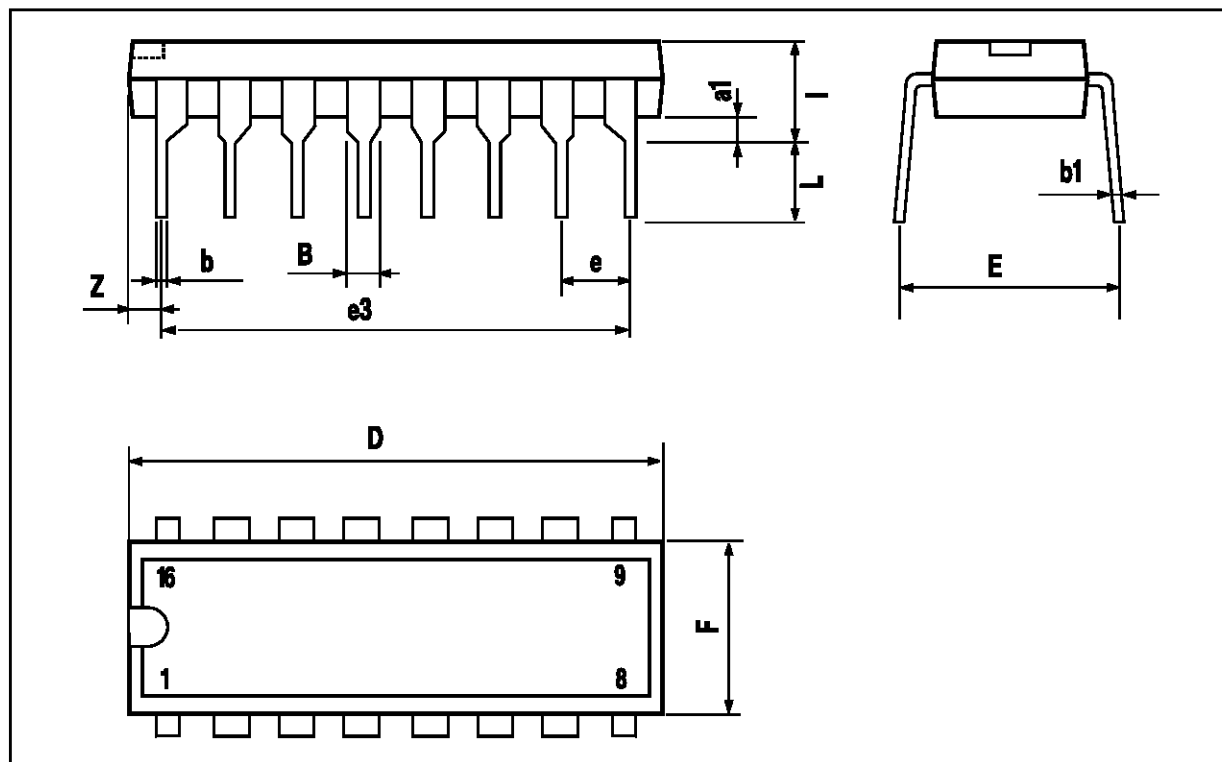
**Figure 7 :** Maximum Allowable Power Dissipation vs. Ambient Temperature.



# TDA2822

## POWERDIP 16 PACKAGE MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	0.85		1.40	0.033		0.055
b		0.50			0.020	
b1	0.38		0.50	0.015		0.020
D			20.0			0.787
E		8.80			0.346	
e		2.54			0.100	
e3		17.78			0.700	
F			7.10			0.280
I			5.10			0.201
L		3.30			0.130	
Z			1.27			0.050



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